



PRODUCT DATASHEET



- PLCC Side View SMD with IC (6-Pins)
- 4516ICSV 1.6t Series
- ► Red/Green/Blue

NOM67S07ICSV





APPLICATIONS:

- Telecommunication
- Home Appliance
- Decoration Lighting
- Full Colour LED Strip
- Gaming Device
- Curtain LED Display

Support sleep/wake up mode. In sleep mode the LED's current was lower than 5µA

4516 IC-Integrated compliant

FEATURES:

- Package: PLCC Side View EIA STD LED with Integrated IC
- Forward Current: 20mA/Channel
- Forward Voltage (typ.): +4.5~+5.5V * in order of R/G/B
- Luminous Intensity (typ.): 750/1450/240mcd*
- Mixed White Intensity (typ.): 2050mcd
- Colour: Red/Green/Blue
- Dominant Wavelength: 622/520/467nm
- Viewing angle: 120°
- Materials:
 - Resin: Silicone (White Diffused)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+105°C
- IC Feature:

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One Pixel contains R, G, and B colour each can achieve 256 level brightness greyscales, which form 16,777,216 combination colours. Serial data transmission signal by DATA & CLK two lines. Support sleep/wake-up mode. In sleep mode current lower than 5μ A.

- Soldering methods: IR Reflow soldering
- Preconditioning: acc. to JEDEC Level 3
- Packing: 12mm tape with max.2000pcs/reel, ø180mm (7")

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CHARACTERISTICS:

Parameter	Symbol	Ratings	Unit
IC Power Supply Voltage	Vdd	Max. 6.5	V
Rate of Data Signal	Fclk	15	MHz
Max. LED Output Current	Іомах	20/channel	mA
Power Dissipation	PD	Max. 400	mW
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Т _{ѕтб}	-40~+105	°C
Electrostatic Discharge (HBM)	ESD	6000	V
Soldering Temperature (for max. 10s)	T _{SD}	260	°C

Absolute Maximum Characteristics (T_a=25°C)

Electrical & Optical Characteristics (T_a=25°C)

Devenueter	Values					Test	
Parameter		Symbol	Min. Typ.		Max.	Unit	Condition
	R			750			
Luminous Intensity	G	lv		1450		mcd	I⊧=20mA
	В			240			
Mixed White Intensity	W	lv		2050		mcd	
Forward Voltage		VF	4.5		5.5	V	I⊧=20mA
	R		615		630		
Dominant Wavelength	G	λ_{d}	515		525	nm	I⊧=20mA
	В		460		475		
Colour Coordinate	х			0.2661			I⊧=20mA
	Y			0.2846			IF-2011A
Viewing Angle		2 θ 1/2		120		deg	I⊧=20mA



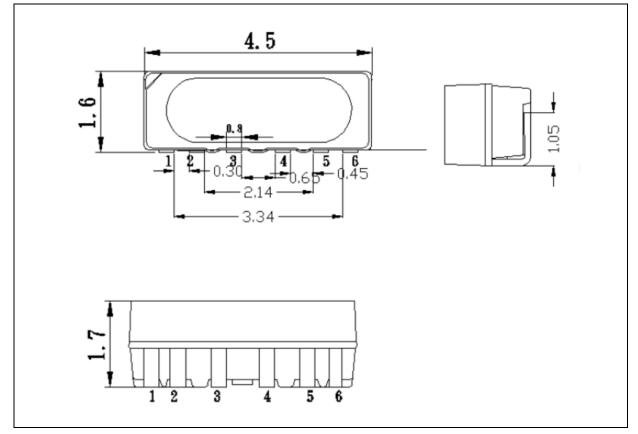
Daramatar	Sumbol		Unit	Test		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Supply Voltage	V _{DD}	4.5	5.0	5.5	V	
	Vih	2.7		V _{DD} +0.4	V	
Input Voltage Level	VIL	-0.4		1.0	V	
Clock High Level Width	Тсікн	30			ns	
Clock Low Level Width	T _{CLKL}	30			ns	
Data Set-Up Time	TSETUP	10			ns	
Data Hold Time	THOLD	5			ns	
Working Current (IC)	I _{DD}			2	mA	I _{out} =OFF
Static Current	Isleep			5	μΑ	Sleep Mode
Rate of Data Signal	Fclk	1		15	MHz	

Electrical & Optical Characteristics (T_a=25°C, V_{DD}=5V)



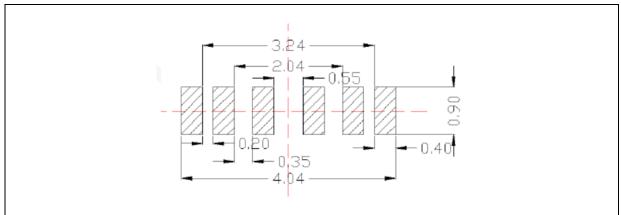
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

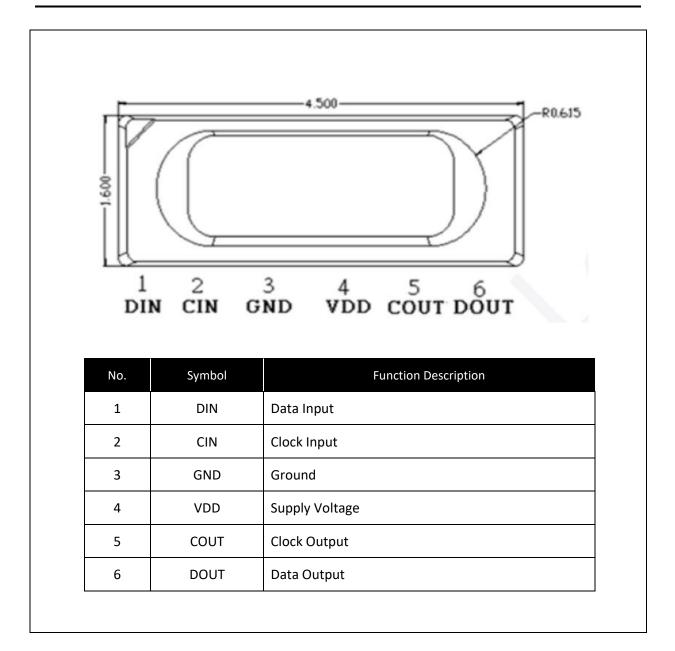
Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.

PIN CONFIGURATION:





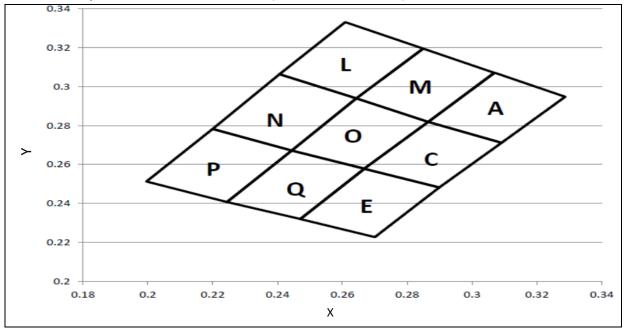


BINNING GROUPS:

Code	Min.	Max.	Unit			
16	1300	1700				
17	1700	2200	mcd			
18	2200	2800				

Luminous Intensity Classifications (V_{DD}=5V, I_F=20mA*3):

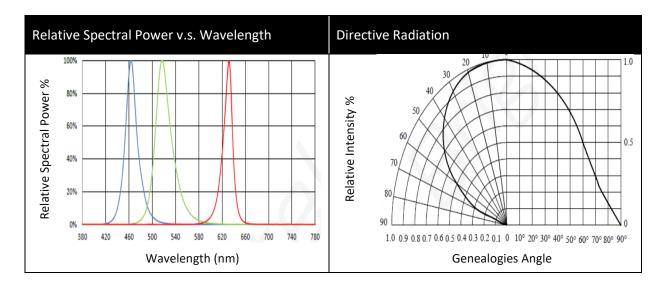
Chromaticity Coordinate Classifications (V_{DD}=5V, I_F=20mA*3):

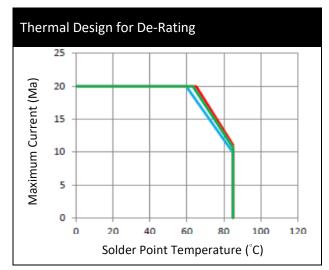


	1	1	2		3		4	
	Х	Y	х	Y	х	Y	х	Y
L	0.2406	0.3064	0.2609	0.3332	0.2849	0.3196	0.2643	0.2940
М	0.2643	0.2940	0.2849	0.3196	0.3068	0.3072	0.2865	0.2819
Ν	0.2200	0.2783	0.2406	0.3064	0.2643	0.2940	0.2444	0.2672
0	0.2444	0.2672	0.2643	0.2940	0.2865	0.2819	0.2667	0.2578
Р	0.2200	0.2783	0.1996	0.2513	0.2244	0.2407	0.2444	0.2672
Q	0.2444	0.2672	0.2244	0.2407	0.2471	0.2320	0.2669	0.2579
А	.3070	0.3072	0.3287	0.2948	0.3091	0.2712	0.2865	0.2819
С	0.2865	0.2819	0.3091	0.2712	0.2899	0.2482	0.2667	0.2578
E	0.2667	0.2578	0.2899	0.2482	0.2700	0.2227	0.2470	0.2320



ELECTRO-OPTICAL CHARACTERISTICS:







Function Description:

1. Tandem N-LED:

t	\rightarrow						
SDI '0'*32	LED1	LED2	LED3	LED4		LEDN	ʻ1'*32
Start Frame	←→ LED Fra	me				>	End Frame
			Data fi	eld			
2							
Start	Frame	' 0'*8	'0'* 8	"0"*8	' 0'*8		
		8 bits	8 bits	8 bits	8 bits		
		·				\sim	_
LED Frame	32 Bits	111	Dim	bule	green	red	
		3 bits	5 bits	8 bits	8 bits	8 bits	
End	Frame	'1'*8	'1'* 8	'1'* 8	'1'*8		
		8 bits	8 bits	8 bits	8 bits	-	

2. Dim 5-Bit (level 32) brightness adjustment (simultaneous control of OUTR/OUTG/OUTB three port current):

DATA MSB ↔ LSB	Driving Current
00000	0/31
00001	1/31
00010	2/31
11110	30/31
11111	31/31 (max)

3. PWM input/output signal relations, IC receives data at rising edge of CLK:

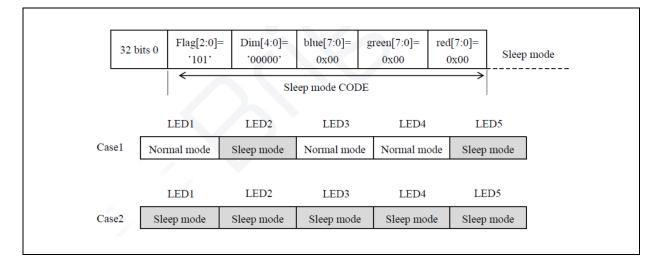
CIN 00000000 0/255(min) DIN B31 B30 B29 B28 B2 B1 B0 COUT COUT 11111101 253/255 11111110 254/255			Data MSB	Duty Cycle
DIN B31 B30 B29 B28 B2 B1 B0 00000010 2/255 COUT International and an an an and an	CIN			0/255(min)
COUT DOUT DOUT 11111101 253/255 11111110 254/255			00000001	1/255
COUT 11111101 253/255 DOUT 11111110 254/255	DIN	B31 B30 B29 B28 B2 B1 B0	00000010	2/255
DOLIT DU DU <thd< td=""><td></td><td></td><td></td><td></td></thd<>				
	COUT		11111101	253/255
DOUT B31 B30 B29 B28 B2 B1 B0 11111111 255/255(max)			11111110	254/255
	DOUT	B31 B30 B29 B28 B2 B1 B0	1111111	255/255(max)



4. Sleep and power saving mode:

LED supports sleep/wake-up modes for power-saving purposes. After the IC receives 24-bit 0's BGR data (that is B[7:0]=8h00, G[7:0]=8h00, R[7:0]=8h00), in the meantime, both of the data in 3-bits FLAG and 5-bits DIMMING is 8h' A0' (that is FLAG[2:0]=3b101 and DIMMING [4:0]=5b00000), the IC will enter sleep mode, its current is about 1uA.

The IC will wake up from sleep mode once receiving the new data with the data of Flag[2:0], DIMMING [4:0] is not 8h"A0"; after wake-up, all sleeping circuits in IC return to normal working mode within 1ms. Since it takes 1ms for a sleeping IC to return to normal function mode, it is recommended for a host to wait for 1ms to send display data and command after issuing a wake-up command.

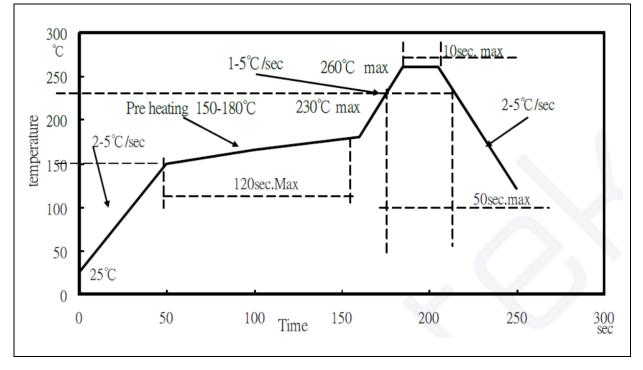


In case 1, while lamp2 is under sleep mode, in the following data transfer process, the state of lamp 2 will be not changed as long as the 32 bits data for lamp 2 is received with data of FLAG[2:0], DIMMING[4:0] being 8h"A0". It means lamp2 will keep in sleep mode as well. In this situation, lamp2 can pass through the remaining data to lamp 3 (32bits) to change the display data of lamp 3. In other words, the sleeping chip is able to pass the data to the next chips.



RECOMMENDED SOLDERING PROFILE:





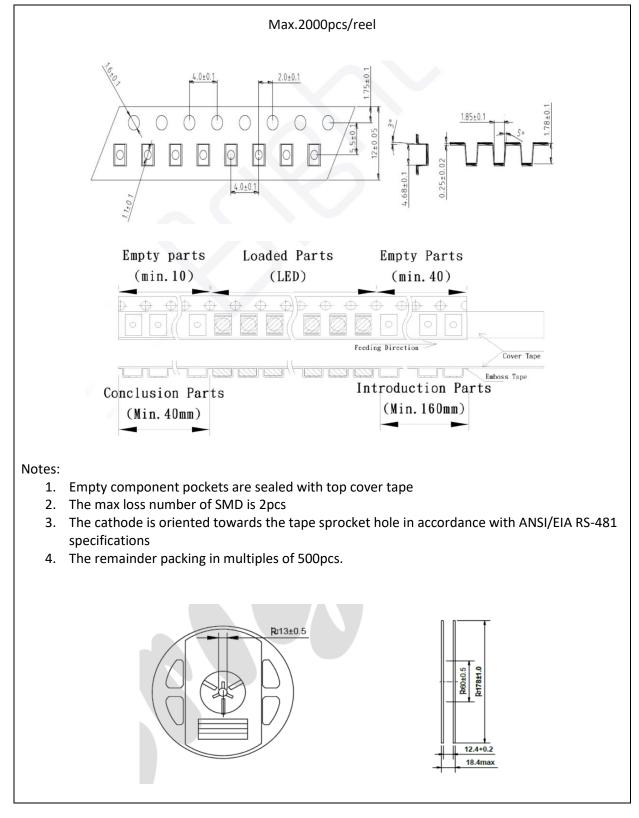
Note:

- 1. We recommend the reflow temperature 240°C (±5°C). The maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 1 time.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 4 weeks. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

Over-Current Proof:

Must apply resistors for protection otherwise slight voltage shift will cause big current change and burnout will happen.

Baking:

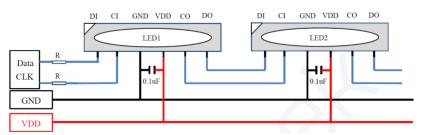
It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:

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When the first LED is connected to the MCU, a resistance R is needed in series between its signal input line and the MCU. The size of R depends on the number of cascade beads. The more cascades, the smaller resistance R is used. It is generally recommended that the value be between 100-1K. Usually the recommended value is around 300R. In order to make the LEDs work more stably, a parallel capacitor is needed between VDD and GND of each.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	08/09/2024	Datasheet set-up.